

WSD3042DN56

N-Ch MOSFET

General Description

The WSD3042DN56 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD3042DN56 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

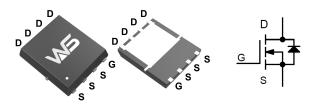
Product Summery

BVDSS	RDSON	ID
30V	9mΩ	40A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

DFN5X6-8 Pin Configuration



Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I₀@T₀=25℃	Continuous Drain Current, V _{GS} @ 10V ¹	40	A
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	26	A
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	9	A
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ 10V ¹	7	A
I _{DM} @Тс=25℃	300µs Pulse Drain Current Tested ²	90	A
EAS	Single Pulse Avalanche Energy ³	20	mJ
I _{AS}	Avalanche Current	10	А
P _D @T _C =25℃	Total Power Dissipation ⁴	32	W
P _D @T _C =100℃	Total Power Dissipation ⁴	12.8	W
T _{STG}	Storage Temperature Range -55 to 1		°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eJA}	Thermal Resistance Junction-Ambient ¹		47	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		3.9	°C/W

Absolute Maximum Ratings



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Electrical Characteristics (T_J=25⁻¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$, I_D=1mA		0.027		V/℃
Б	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =20A		9	10.8	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =10A		9.6	12	mΩ
V _{GS(th)}	Gate Threshold Voltage		0.5	0.85	1.3	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	— V _{GS} =V _{DS} , I _D =250uA		-5.8		mV/℃
1	Drain Source Lookage Current	V_{DS} =24V , V_{GS} =0V , T_J =25 $^{\circ}$ C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55℃			5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		40		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		0.9	2.0	Ω
Qg	Total Gate Charge (4.5V)			16	21	
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =20A		2.8	3.5	nC
Q _{gd}	Gate-Drain Charge			3.7	4.4	
T _{d(on)}	Turn-On Delay Time			12	18	
Tr	Rise Time	V _{DD} =15V , V _{GS} =10V , R _G =6Ω I _D =1A ,RL=15Ω		10	15	
T _{d(off)}	Turn-Off Delay Time			24	40	ns
T _f	Fall Time			5.5	8	
Ciss	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		1150	1500	
C _{oss}	Output Capacitance			120	228	pF
C _{rss}	Reverse Transfer Capacitance			85	183	

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.1mH , I _{AS} =10A	20			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}				10	А
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			36	А
V _{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1	V
t _{rr}	Reverse Recovery Time			11.6		nS
Qrr	Reverse Recovery Charge	lَF=20A , dl/dt=100A/μs , T _J =25℃		4.8		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t < 10 sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.5\text{mH}, \text{I}_{\text{AS}}\text{=}20\text{A}$

4. The power dissipation is limited by 150 °C junction temperature

5.The Min. value is 100% EAS tested guarantee.

6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



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Typical Characteristics

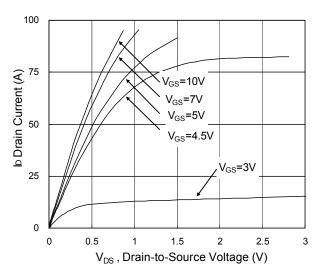


Fig.1 Typical Output Characteristics

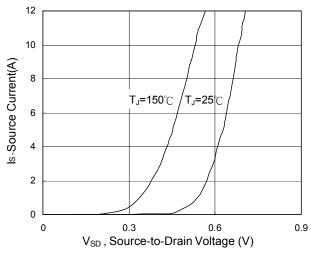


Fig.3 Forward Characteristics of reverse

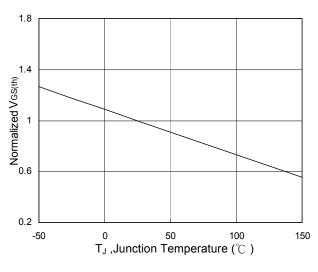


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

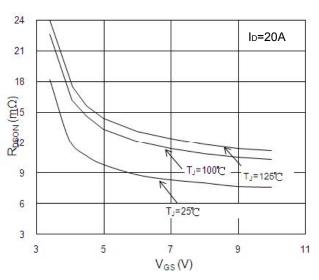


Fig.2 On-Resistance vs. Gate-Source

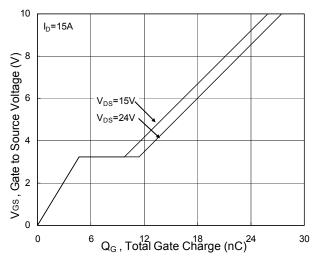


Fig.4 Gate-Charge Characteristics

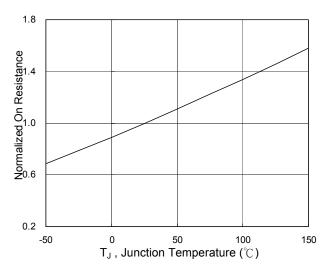
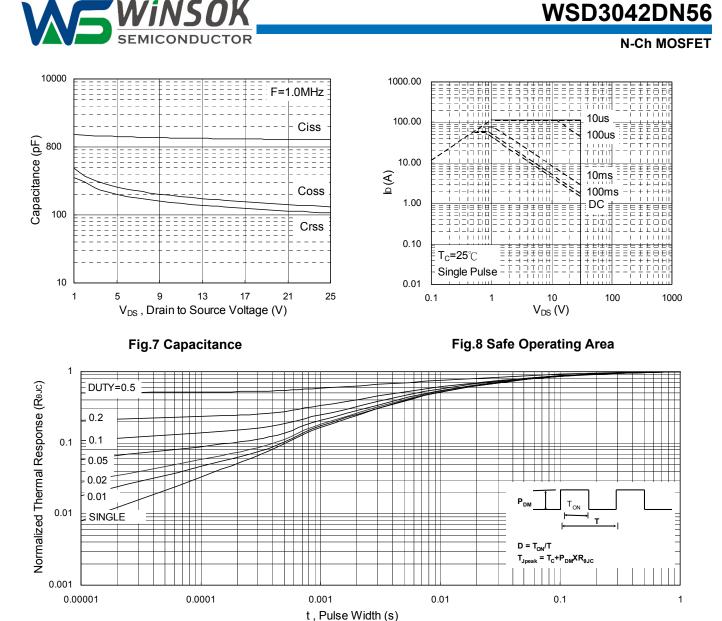
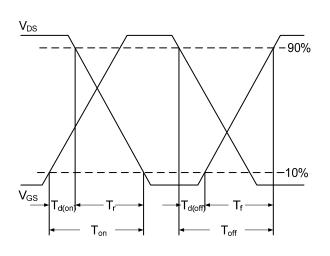
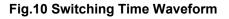


Fig.6 Normalized R_{DSON} vs. T_{J}









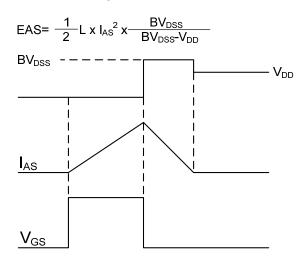


Fig.17 Unclamped Inductive Switching Waveform



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